

Data sheet Product ICK LED R 200 x 40



Heatsinks and active heatsinks for processors>Heatsinks for LEDs
 Ø 200 x 40 mm, for IC design LED

Features

diameter:	200 mm
way of fixation:	<ul style="list-style-type: none"> • therm. conductive foil • therm. cond. adhesive
height:	40 mm
plate thickness:	10 mm
thermal resistance:	1 K/W
dissipation loss:	51 W
surface:	black anodised

Technical Drawing

